

Data Sheet June 21, 2010 FN6035.2

QFN Packaged, ±15kV ESD Protected, +3V to +5.5V, 150nA, 250kbps, RS-232 Transmitters/Receivers with Separate Logic Supply

The ISL4260E contains 3.0V to 5.5V powered RS-232 transmitters/receivers which meet EIA/TIA-232 and V.28/V.24 specifications, even at V_{CC} = 3.0V. Targeted applications are PDAs, Palmtops, and cell phones where the low operational, and even lower standby, power consumption is critical. Efficient on-chip charge pumps, coupled with a manual powerdown function reduces the standby supply current to a 150nA trickle. Tiny 5mm x 5mm Quad Flat No-Lead (QFN) packaging, and the use of small, low value capacitors ensure board space savings as well. Data rates greater than 250kbps are guaranteed at worst case load conditions.

The ISL4260E features a V_L pin that adjusts the logic pin (see Pin Descriptions table) output levels and input thresholds to values compatible with the V_{CC} powering the external logic (e.g., a UART).

The single pin powerdown function ($\overline{SHDN} = 0$) disables all the receiver and transmitter outputs, while shutting down the charge pump to minimize supply current drain.

Table 1 summarizes the features of the ISL4260E, while Application Note AN9863 summarizes the features of each device comprising the 3V RS-232 family.

Ordering Information

| PART NUMBER | PART MARKING | TEMP. RANGE (°C) | PACKAGE | PKG. DWG. #. |
|------------------------|-----------------|------------------------|--------------------------|-----------------|
| ISL4260EIRZ* (Note) | ISL4260 EIRZ | -40 to +85 | 32 Lead QFN (Pb-free) | L32.5x5B |

^{*}Add "-T" suffix for tape and reel. Please refer to TB347 for details on reel specifications.

NOTE: These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

Features

- · Available in Near Chip Scale QFN (5mmx5mm) Package
- V_L Pin for Compatibility with Mixed Voltage Systems
- ESD Protection for RS-232 I/O Pins to ±15kV (IEC61000)
- Single SHDN Pin Disables Transmitters and Receivers
- Meets EIA/TIA-232 and V.28/V.24 Specifications at 3V
- On-Chip Charge Pumps Require Only Four External 0.1μF Capacitors
- · Receiver Hysteresis For Improved Noise Immunity
- Guaranteed Minimum Data Rate 250kbps
- Wide Power Supply Range Single +3V to +5.5V
- Low Supply Current in Powerdown State......150nA
- · Pb-Free (RoHS Compliant)

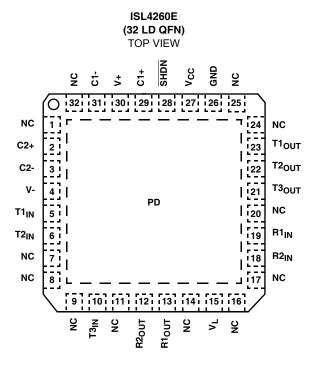
Applications

- Any System Requiring RS-232 Communication Ports
 - Battery Powered, Hand-Held, and Portable Equipment
 - Laptop Computers, Notebooks, Palmtops
 - Digital Cameras
 - PDAs and PDA Cradles
 - Cellular/Mobile Phones

| TABLE 1 | SUMMARY OF FFATUR | RES |
|---------|-------------------|-----|

| PART NUMBER | NO. OF Tx. | NO. OF Rx. | DATA RATE (kbps) | Rx. ENABLE FUNCTION? | V _L LOGIC SUPPLY PIN? | MANUAL POWER- DOWN? | AUTOMATIC POWERDOWN FUNCTION? |
|----------------|---------------|---------------|---------------------|----------------------|-------------------------------------|------------------------|-------------------------------|
| ISL4260E | 3 | 2 | 250 | NO | YES | YES | NO |

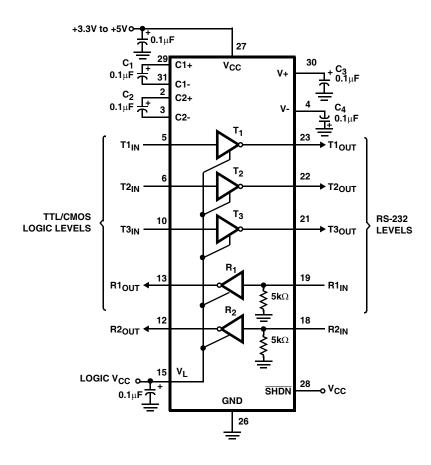
Pinout



Pin Descriptions

| PIN | FUNCTION |
|------------------|--|
| V_{CC} | System power supply input (3.0V to 5.5V). |
| V+ | Internally generated positive transmitter supply (+5.5V). |
| V- | Internally generated negative transmitter supply (-5.5V). |
| GND | Ground connection. This is also the potential of the thermal pad (PD). |
| C1+ | External capacitor (voltage doubler) is connected to this lead. |
| C1- | External capacitor (voltage doubler) is connected to this lead. |
| C2+ | External capacitor (voltage inverter) is connected to this lead. |
| C2- | External capacitor (voltage inverter) is connected to this lead. |
| T_{IN} | TTL/CMOS compatible transmitter Inputs. The switching point is a function of the V _L voltage. |
| T _{OUT} | ±15kV ESD Protected, RS-232 level (nominally ±5.5V) transmitter outputs. |
| R _{IN} | ±15kV ESD Protected, RS-232 compatible receiver inputs. |
| R _{OUT} | TTL/CMOS level receiver outputs. Swings between GND and V _L . |
| V_{L} | Logic-Level Supply. All TTL/CMOS inputs and outputs are powered by this supply. |
| SHDN | Active low TTL/CMOS input to tri-state receiver and transmitter outputs and to shut down the on-board power supply to place device in low power mode. The switching point is a function of the V _L voltage. |
| NC | No Connection |
| PD | Exposed Thermal Pad. Connect to GND. |

Typical Operating Circuit



Absolute Maximum Ratings

| V _{CC} to Ground0.3V to 6V |
|---|
| V _I to Ground0.3V to 7V |
| V+ to Ground0.3V to 7V |
| V- to Ground +0.3V to -7V |
| V+ to V |
| Input Voltages |
| T _{IN} , SHDN |
| R _{IN} |
| Output Voltages |
| T _{OUT} |
| R _{OUT} 0.3V to (V _L +0.3V) |
| Short Circuit Duration |
| T _{OUT} Continuous |
| ESD Rating See "ESD PERFORMANCE" on page 5 |

Thermal Information

| Thermal Resistance (Typical, Notes 1, 2) | θ _{JA} (°C/W) | θ _{JC} (°C/W) |
|---|------------------------|--------------------------------------|
| 32 Ld QFN Package | 30 | 2.2 |
| Moisture Sensitivity (see Technical Brief T | B363) | |
| QFN Package | | Level 1 |
| Maximum Junction Temperature (Plastic P | ackage) | 150 ^o C |
| Maximum Storage Temperature Range | 65 | ^o C to 150 ^o C |
| Pb-Free Reflow Profile | | ee link below |
| http://www.intersil.com/pbfree/Pb-FreeR | teflow.asp | |
| | | |

Operating Conditions

| Temperature Range | |
|-------------------|--------------|
| ISL4260EIR | 40°C to 85°C |

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTE

- θ_{JA} is measured in free air with the component mounted on a high effective thermal conductivity test board with "direct attach" features. See Tech Brief TB379, and Tech Brief TB389.
- 2. For θ_{JC} , the "case temp" location is the center of the exposed metal pad on the package underside.

Electrical Specifications

Test Conditions: V_{CC} = 3V to 5.5V, C₁ - C₄ = 0.1 μ F, V_L = V_{CC}; Unless Otherwise Specified. Typicals are at T_A = 25°C, V_{CC} = V_L = 3.3V

| PARAMETER | т | TEST CONDITIONS | | MIN (Note 4) | TYP | MAX (Note 4) | UNITS |
|------------------------------|---------------------------------|---|------|----------------------|----------------------|-----------------|-------|
| DC CHARACTERISTICS | | | | | | | |
| Supply Current, Powerdown | SHDN = GND, All In | puts at V _{CC} or GND | 25 | - | 0.15 | 1 | μА |
| Supply Current | All Outputs Unloade | d, $\overline{\text{SHDN}} = V_{CC}$, $V_{CC} = 3.15V$ | 25 | - | 0.3 | 1 | mA |
| LOGIC AND TRANSMITTER IN | IPUTS | | | | | | , |
| Input Logic Threshold Low | T _{IN} , SHDN | V _L = 3.3V or 5V | Full | - | - | 0.8 | V |
| | | V _L = 2.5V | Full | - | - | 0.6 | V |
| Input Logic Threshold High | T _{IN} , SHDN | V _L = 5V | Full | 2.4 | - | - | V |
| | | V _L = 3.3V | Full | 2.0 | - | - | V |
| | | V _L = 2.5V | Full | 1.4 | - | - | V |
| | | V _L = 1.8V | 25 | - | 0.9 | - | V |
| Transmitter Input Hysteresis | | | 25 | - | 0.5 | - | V |
| Input Leakage Current | T _{IN} , SHDN | T _{IN} , SHDN | | | ±0.01 | ±1 | μА |
| RECEIVER OUTPUTS | | | 1 | l | I | | |
| Output Leakage Current | V _{CC} = 0V or 3V to 5 | V _{CC} = 0V or 3V to 5.5V, SHDN = GND | | - | ±0.05 | ±10 | μА |
| Output Voltage Low | I _{OUT} = 1.6mA | I _{OUT} = 1.6mA | | - | - | 0.4 | V |
| Output Voltage High | I _{OUT} = -1.0mA | | Full | V _L - 0.6 | V _L - 0.1 | - | V |
| RECEIVER INPUTS | | | | I | I. | I | |
| Input Voltage Range | | | Full | -25 | - | 25 | V |
| Input Threshold Low | V _L = 5.0V | V _L = 5.0V | | 0.8 | 1.5 | - | V |
| | V _L = 3.3V | | 25 | 0.6 | 1.2 | - | V |
| Input Threshold High | V _L = 5.0V | V _L = 5.0V | | - | 1.8 | 2.4 | V |
| | V _L = 3.3V | | 25 | - | 1.5 | 2.4 | V |
| Input Hysteresis | | | 25 | - | 0.5 | - | V |

Electrical Specifications

Test Conditions: V_{CC} = 3V to 5.5V, C_1 - C_4 = 0.1 μ F, V_L = V_{CC} ; Unless Otherwise Specified. Typicals are at T_A = 25 o C, V_{CC} = V_L = 3.3V **(Continued)**

| PARAMETER | TEST CONDITIONS | | TEMP (°C) | MIN (Note 4) | ТҮР | MAX (Note 4) | UNITS |
|---|--|----------------------------------|--------------|-----------------|------|-----------------|-------|
| Input Resistance | | | | 3 | 5 | 7 | kΩ |
| TRANSMITTER OUTPUTS | | | | ' | | | |
| Output Voltage Swing | All Transmitter Outputs Load | ded with 3kΩ to Ground | Full | ±5.0 | ±5.4 | - | V |
| Output Resistance | V _{CC} = V+ = V- = 0V, Transn | nitter Output = ±2V | Full | 300 | 10M | - | Ω |
| Output Short-Circuit Current | Shorted to GND | | Full | - | - | ±60 | mA |
| Output Leakage Current | V _{OUT} = ±12V, V _{CC} = 0V or 3 | 3V to 5.5V, SHDN = GND | Full | - | - | ±25 | μА |
| TIMING CHARACTERISTICS | | | | ' | | | |
| Maximum Data Rate | $R_L = 3k\Omega$, $C_L = 1000pF$, One | e Transmitter Switching | Full | 250 | 500 | - | kbps |
| Receiver Propagation Delay | Receiver Input to Receiver Output, C _L = 150pF | t _{PHL} | 25 | - | 0.15 | - | μS |
| | | t _{PLH} | 25 | - | 0.15 | - | μS |
| Receiver Output Enable Time | | | | - | 200 | - | ns |
| Receiver Output Disable Time | | | 25 | - | 200 | - | ns |
| Transmitter Output Enable Time | From SHDN Rising Edge to | T _{OUT} = ±3.7V | 25 | - | 100 | - | μS |
| Transmitter Skew | t _{PHL} - t _{PLH} (Note 3) | | 25 | - | 100 | - | ns |
| Receiver Skew | t _{PHL} - t _{PLH} | | 25 | - | 50 | - | ns |
| Transition Region Slew Rate | $R_L = 3k\Omega$ to $7k\Omega$, | C _L = 150pF to 1000pF | 25 | 6 | 18 | 30 | V/μs |
| | Measured From 3V to -3V or $-3V$ to 3V, $V_{CC} = 3.3V$ | C _L = 150pF to 2500pF | 25 | 4 | 13 | 30 | V/μs |
| ESD PERFORMANCE | | | | | | | |
| RS-232 Pins (T _{OUT} , R _{IN}) | Human Body Model | | 25 | - | ±15 | - | kV |
| | IEC61000-4-2 Air Gap Discharge | | 25 | - | ±15 | - | kV |
| | IEC61000-4-2 Contact Disch | IEC61000-4-2 Contact Discharge | | - | ±8 | - | kV |

NOTE:

- 3. Transmitter skew is measured at the transmitter zero crossing points.
- 4. Parameters with MIN and/or MAX limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested.

Detailed Description

The ISL4260E operates from a single +3V to +5.5V supply, guarantees a 250kbps minimum data rate, requires only four small external $0.1\mu\text{F}$ capacitors, features low power consumption, and meets all EIA RS-232C and V.28 specifications. The circuit is divided into three sections: The charge pump, the transmitters, and the receivers.

Charge-Pump

Intersil's new ISL4260E utilizes regulated on-chip dual charge pumps as voltage doublers, and voltage inverters to generate $\pm 5.5 V$ transmitter supplies from a V_{CC} supply as low as 3.0V. This allows these devices to maintain RS-232 compliant output levels over the $\pm 10\%$ tolerance range of 3.3V powered systems. The efficient on-chip power supplies require only four small, external $0.1\mu F$ capacitors for the voltage doubler and inverter functions over the full V_{CC} range; other capacitor combinations can be used as shown

in Table 3. The charge pumps operate discontinuously (i.e., they turn off as soon as the V+ and V- supplies are pumped up to the nominal values), resulting in significant power savings.

Transmitters

The transmitters are proprietary, low dropout, inverting drivers that translate TTL/CMOS inputs to EIA/TIA-232 output levels. Coupled with the on-chip ± 5.5 V supplies, these transmitters deliver true RS-232 levels over a wide range of single supply system voltages.

All transmitter outputs disable and assume a high impedance state when the device enters the powerdown mode (see Table 2). These outputs may be driven to $\pm 12V$ when disabled.

All devices guarantee a 250kbps data rate for full load conditions (3k Ω and 1000pF), V_{CC} \geq 3.0V, with one

transmitter operating at full speed. Under more typical conditions of V $_{CC} \ge 3.3$ V, R $_{L}$ = 3k Ω , and C $_{L}$ = 250pF, one transmitter easily operates at 1.25Mbps.

The transmitter input threshold is set by the voltage applied to the V_L pin. Transmitter inputs float if left unconnected (there are no pull-up resistors), and may cause I_{CC} increases. Connect unused inputs to GND for the best performance.

TABLE 2. POWERDOWN TRUTH TABLE

| SHDN INPUT | TRANSMITTER OUTPUTS | _ | MODE OF OPERATION |
|---------------|---------------------|--------|-------------------|
| L | High-Z | High-Z | Manual Powerdown |
| Н | Active | Active | Normal Operation |

Receivers

The ISL4260E contains standard inverting receivers that convert RS-232 signals to CMOS output levels and accept inputs up to $\pm 25 V$ while presenting the required $3 k \Omega$ to $7 k \Omega$ input impedance (see Figure 1) even if the power is off (VCC = 0V). The receivers' Schmitt trigger input stage uses hysteresis to increase noise immunity and decrease errors due to slow input signal transitions. Receiver outputs swing from GND to V_I , and tristate in powerdown.

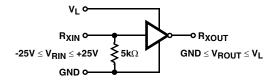


FIGURE 1. RECEIVER CONNECTIONS

Low Power Operation

This 3V device requires a nominal supply current of 0.3mA, even at V_{CC} = 5.5V, during normal operation (not in powerdown mode). This is considerably less than the 11mA current required by comparable 5V RS-232 devices, allowing users to reduce system power simply by replacing the old style device with the ISL4260E in new designs.

Powerdown Functionality

The already low current requirement drops significantly when the device enters powerdown mode. In powerdown, supply current drops to 150nA, because the on-chip charge pump turns off (V+ collapses to V_{CC} , V- collapses to GND), and the transmitter and receiver outputs tristate. This micropower mode makes these devices ideal for battery powered and portable applications.

Software Controlled (Manual) Powerdown

The ISL4260E may be forced into its low power, standby state via a simple shutdown (\overline{SHDN}) pin (see Figure 2). Driving this pin high enables normal operation, while driving it low forces the IC into its powerdown state. The time

required to exit powerdown, and resume transmission is less than 100 μ s. Connect SHDN to V_{CC} if the powerdown function isn't needed.

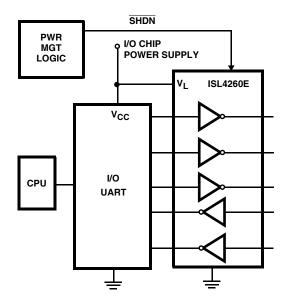


FIGURE 2. CONNECTIONS FOR MANUAL POWERDOWN

V_L Logic Supply Input

Unlike other RS-232 interface devices where the CMOS outputs swing between 0 and V_{CC}, the ISL4260E features a separate logic supply input (VL; 1.8V to 5V, regardless of V_{CC}) that sets V_{OH} for the receiver outputs. Connecting V_L to a host logic supply lower than V_{CC}, prevents the ISL4260E outputs from forward biasing the input diodes of a logic device powered by that lower supply. Connecting V_I to a logic supply greater than V_{CC} ensures that the receiver output levels are compatible even with the CMOS input VIH of AC, HC, and CD4000 devices. Note that the V_L supply current increases to $100\mu A$ with $V_{L} = 5V$ and $V_{CC} = 3.3V$ (see Figure 11). V_I also powers the transmitter and logic inputs, thereby setting their switching thresholds to levels compatible with the logic supply. This separate logic supply pin allows a great deal of flexibility in interfacing to systems with different logic supplies. If logic translation isn't required, connect V_I to the ISL4260E V_{CC}.

Capacitor Selection

The ISL4260E charge pumps only require $0.1\mu F$ capacitors for the full operational voltage range. Table 3 lists other acceptable capacitor values for various supply voltage ranges. Do not use values smaller than those listed in Table 3. Increasing the capacitor values (by a factor of 2) reduces ripple on the transmitter outputs and slightly reduces power consumption.

TABLE 3. REQUIRED CAPACITOR VALUES

| V _{CC} (V) | C ₁ (μF) | C ₂ , C ₃ , C ₄ (μ F) |
|---------------------|------------------------|---|
| 3.0 to 3.6 | 0.1 | 0.1 |
| 4.5 to 5.5 | 0.047 | 0.33 |
| 3.0 to 5.5 | 0.22 | 1 |

When using minimum required capacitor values, make sure that capacitor values do not degrade excessively with temperature. If in doubt, use capacitors with a larger nominal value. The capacitor's equivalent series resistance (ESR) usually rises at low temperatures and it influences the amount of ripple on V+ and V-.

Power Supply Decoupling

In most circumstances a $0.1\mu F$ bypass capacitor is adequate. In applications that are particularly sensitive to power supply noise, decouple V_{CC} to ground with a capacitor of the same value as the charge-pump capacitor $C_1.$ Connect the bypass capacitor as close as possible to the IC.

Transmitter Outputs when Exiting Powerdown

Figure 3 shows the response of two transmitter outputs when exiting powerdown mode. As they activate, the two transmitter outputs properly go to opposite RS-232 levels, with no glitching, ringing, nor undesirable transients. Each transmitter is loaded with $3k\Omega$ in parallel with 2500pF. Note that the transmitters enable only when the magnitude of the supplies exceed approximately 3V.

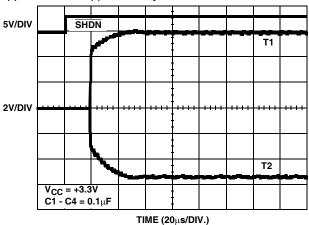


FIGURE 3. TRANSMITTER OUTPUTS WHEN EXITING POWERDOWN

High Data Rates

The ISL4260E maintains the RS-232 ± 5 V minimum transmitter output voltages even at high data rates. Figure 4 details a transmitter loopback test circuit, and Figure 5 illustrates the loopback test result at 120kbps. For this test, all transmitters were simultaneously driving RS-232 loads in parallel with 1000pF, at 120kbps. Figure 6 shows the

loopback results for a single transmitter driving 1000pF and an RS-232 load at 250kbps. The static transmitters were also loaded with an RS-232 receiver.

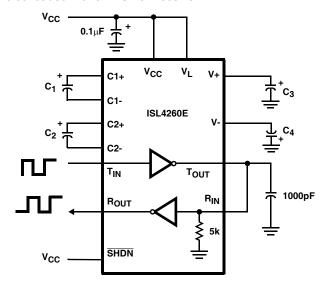


FIGURE 4. TRANSMITTER LOOPBACK TEST CIRCUIT

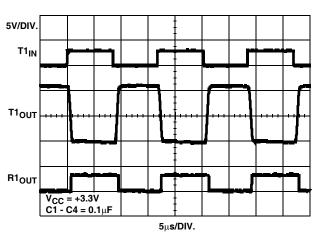


FIGURE 5. LOOPBACK TEST AT 120kbps

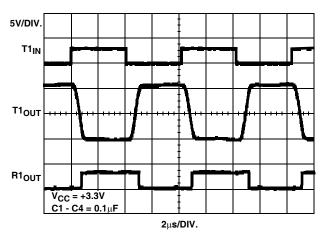


FIGURE 6. LOOPBACK TEST AT 250kbps

Interconnection with 3V and 5V Logic

Standard 3.3V powered RS-232 devices interface well with 3V and 5V powered TTL compatible logic families (e.g., ACT and HCT), but the logic outputs (e.g., R_{OUTS}) fail to reach the V_{IH} level of 5V powered CMOS families like HC, AC, and CD4000. The ISL4260E V_L supply pin solves this problem. By connecting V_L to the same supply (1.8V to 5V) powering the logic device, the ISL4260E logic outputs will swing from GND to the logic V_{CC} .

±15kV ESD Protection

All pins on the 3V interface devices include ESD protection structures, but the ISL4260E incorporates advanced structures which allow the RS-232 pins (transmitter outputs and receiver inputs) to survive ESD events up to $\pm 15 \rm kV$. The RS-232 pins are particularly vulnerable to ESD damage because they typically connect to an exposed port on the exterior of the finished product. Simply touching the port pins, or connecting a cable, can cause an ESD event that might destroy unprotected ICs. These new ESD structures protect the device whether or not it is powered up, protect without allowing any latchup mechanism to activate, and don't interfere with RS-232 signals as large as $\pm 25 \rm V$.

Human Body Model (HBM) Testing

As the name implies, this test method emulates the ESD event delivered to an IC during human handling. The tester delivers the charge through a $1.5 \mathrm{k}\Omega$ current limiting resistor, making the test less severe than the IEC61000 test which utilizes a 330Ω limiting resistor. The HBM method determines an ICs ability to withstand the ESD transients typically present during handling and manufacturing. Due to the random nature of these events, each pin is tested with respect to all other pins. The RS-232 pins on "E" family devices can withstand HBM ESD events to $\pm 15 \mathrm{kV}$.

IEC61000-4-2 Testing

The IEC61000 test method applies to finished equipment, rather than to an individual IC. Therefore, the pins most likely to suffer an ESD event are those that are exposed to the outside world (the RS-232 pins in this case), and the IC is tested in its typical application configuration (power applied) rather than testing each pin-to-pin combination. The lower current limiting resistor coupled with the larger charge storage capacitor yields a test that is much more severe than the HBM test. The extra ESD protection built into this device's RS-232 pins allows the design of equipment meeting level 4 criteria without the need for additional board level protection on the RS-232 port.

AIR-GAP DISCHARGE TEST METHOD

For this test method, a charged probe tip moves toward the IC pin until the voltage arcs to it. The current waveform delivered to the IC pin depends on approach speed, humidity, temperature, etc., so it is difficult to obtain repeatable results. The "E" device RS-232 pins withstand $\pm 15 \text{kV}$ air-gap discharges.

CONTACT DISCHARGE TEST METHOD

During the contact discharge test, the probe contacts the tested pin before the probe tip is energized, thereby eliminating the variables associated with the air-gap discharge. The result is a more repeatable and predictable test, but equipment limits prevent testing devices at voltages higher than $\pm 8 \text{kV}$. All "E" family devices survive $\pm 8 \text{kV}$ contact discharges on the RS-232 pins.

Typical Performance Curves V_{CC} = 3.3V, T_A = 25°C

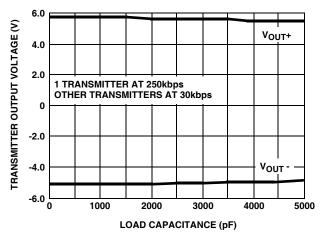


FIGURE 7. TRANSMITTER OUTPUT VOLTAGE vs LOAD CAPACITANCE

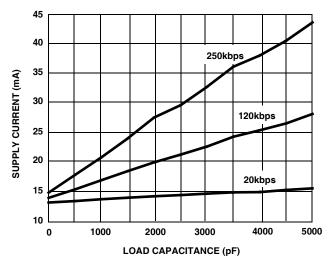


FIGURE 9. SUPPLY CURRENT vs LOAD CAPACITANCE WHEN TRANSMITTING DATA

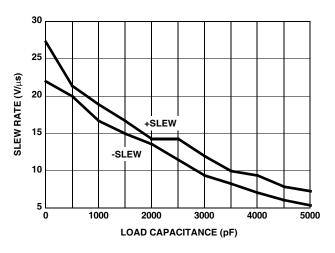


FIGURE 8. SLEW RATE vs LOAD CAPACITANCE

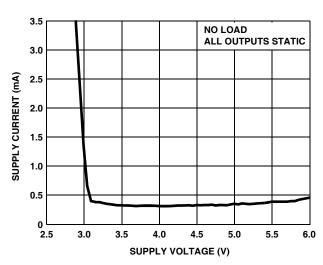


FIGURE 10. SUPPLY CURRENT vs SUPPLY VOLTAGE

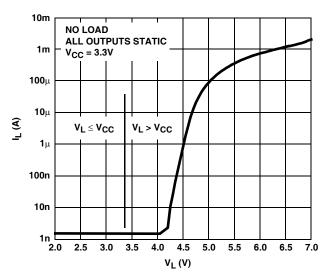


FIGURE 11. V_L SUPPLY CURRENT vs V_L VOLTAGE

Die Characteristics

SUBSTRATE AND QFN THERMAL PAD POTENTIAL (POWERED UP)

GND

TRANSISTOR COUNT

422

PROCESS

Si Gate CMOS

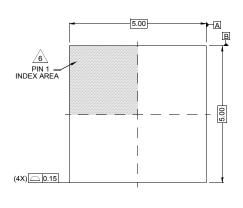
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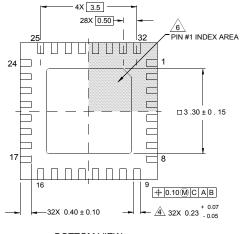
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Package Outline Drawing

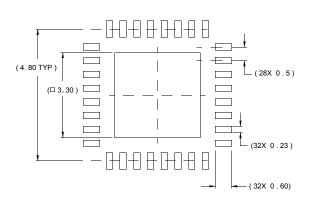
L32.5x5B 32 LEAD QUAD FLAT NO-LEAD PLASTIC PACKAGE Rev 3, 5/10



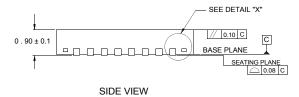
TOP VIEW

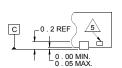


BOTTOM VIEW



TYPICAL RECOMMENDED LAND PATTERN





DETAIL "X"

NOTES:

- Dimensions are in millimeters.
 Dimensions in () for Reference Only.
- 2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
- 3. Unless otherwise specified, tolerance : Decimal ± 0.05
- Dimension applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
- 5. Tiebar shown (if present) is a non-functional feature.
- The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.

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